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Texas Instruments
LMV821QDBVRQ1

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Datasheet of LMV821QDBVRQ1 - IC OPAMP GP 5.5MHZ RRO SOT23-5

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LMV821-Q1 LMV822-Q1 LMV824-Q1

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LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

Check for Samples: LMV821-Q1, LMV822-Q1, LMV824-Q1

FEATURES

- **Qualified for Automotive Applications**
- 2.5-V, 2.7-V, and 5-V Performance
- -40°C to 125°C Operation
- **No Crossover Distortion**
- Low Supply Current at $V_{CC+} = 5 \text{ V}$
 - LMV821: 0.3 mA Typ
 - LMV822: 0.5 mA Typ
 - LMV824: 1 mA Typ
- Rail-to-Rail Output Swing
- Gain Bandwidth of 5.5 MHz Typ at 5 V
- Slew Rate of 1.9 V/µs Typ at 5 V

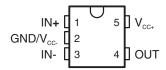
DESCRIPTION/ORDERING INFORMATION

The LMV821 single, LMV822 dual, and LMV824 quad devices are low-voltage (2.5 V to 5.5 V), low-power operational amplifiers. commodity Electrical characteristics are very similar to the LMV3xx operational amplifiers (low supply current, rail-to-rail outputs, input common-mode range that includes ground). However, the LMV82x devices offer a higher bandwidth (5.5 MHz typical) and faster slew rate (1.9 V/µs typical).

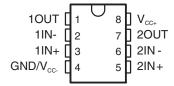
The LMV82x devices are cost-effective solutions for applications requiring low-voltage/low-power operation and space-saving considerations. The LMV821 saves space on printed circuit boards and enables the design of small portable electronic devices (cordless and cellular phones, laptops, PDAs, PCMIA). It also allows the designer to place the device closer to the signal source to reduce noise pickup and increase signal integrity.

The LMV82x devices are characterized for operation from -40°C to 125°C.

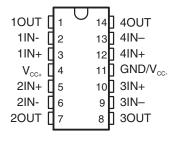
LMV821...DBV PACKAGE (TOP VIEW)



LMV822...DGK PACKAGE (TOP VIEW)



LMV824...D OR PW PACKAGE (TOP VIEW)



ORDERING INFORMATION(1)

T _A	PACKAGE ⁽²⁾			ORDERABLE PART NUMBER	TOP-SIDE MARKING(3)
	Single	SOT-23 – DBV	Reel of 3000	LMV821QDBVRQ1	RB1_
10°C to 125°C	Dual	MSOP/VSSOP - DGK	Reel of 2500	LMV822QDGKRQ1	R8B
–40°C to 125°C	Ound	SOIC - D	Reel of 2500	LMV824QDRQ1	LMV824Q
	Quad	TSSOP – PW	Reel of 2000	LMV824QPWRQ1	MV824Q

- For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI (1) web site at www.ti.com.
- Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.
- DBV: The actual top-side marking has one additional character that designates the wafer fab/assembly site.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

LMV824-Q1

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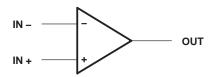
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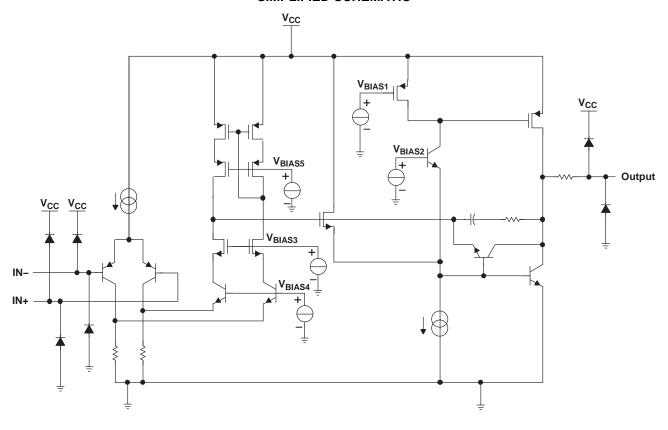
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SYMBOL (EACH AMPLIFIER)



SIMPLIFIED SCHEMATIC





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ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

V_{CC}	Supply voltage (2)	5.5 V	
V_{ID}	Differential input voltage (3)	±V _{CC}	
VI	Input voltage range (either input)	V _{CC} - to V _{CC} +	
	Duration of output short circuit (one amplifier) to ground (4)	At or below $T_A = 25^{\circ}C$, $V_{CC} \le 5.5 \text{ V}$	Unlimited
		D package	97°C/W
0	Package thermal impedance (5) (6)	DBV package	206°C/W
θ_{JA}		DGK package	172°C/W
		PW package	113°C/W
T_J	Operating virtual-junction temperature	150°C	
T _{stg}	Storage temperature range	–65°C to 150°C	

- (1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values (except differential voltages and V_{CC} specified for the measurement of I_{OS}) are with respect to the network GND.
- (3) Differential voltages are at IN+ with respect to IN-.
- (4) Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction.
- (5) Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
- (6) The package thermal impedance is calculated in accordance with JESD 51-7.

RECOMMENDED OPERATING CONDITIONS

		MIN	MAX	UNIT
V_{CC}	Supply voltage (single-supply operation)	2.5	5	V
T _A	Operating free-air temperature	-40	125	°C

2.5-V ELECTRICAL CHARACTERISTICS

 V_{CC+} = 2.5 V, V_{CC-} = 0 V, V_{IC} = 1 V, V_{O} = 1.25 V, and R_L > 1 M Ω (unless otherwise noted)

	PARAMETER	TEST CONDITIONS		T _A	MIN	TYP	MAX	UNIT
١.,	land the standard			25°C		1	6	\/
V_{IO}	Input offset voltage			-40°C to 125°C			6	mV
			I limb Inval	25°C	2.28	2.37		
		V 05 V B 000 0 to 4 05 V	High level	-40°C to 125°C	2.18			
		$V_{CC+} = 2.5 \text{ V}, R_L = 600 \Omega \text{ to } 1.25 \text{ V}$	1 11	25°C		0.13	0.22	
.,	0.44		Low level	-40°C to 125°C			0.32	
Vo	Output swing		I limb Inval	25°C	2.38	2.46		
		V 05 V D 010 to 4.05 V	High level	-40°C to 125°C	2.28			
		$V_{CC+} = 2.5 \text{ V}, R_L = 2 \text{ k}\Omega \text{ to } 1.25 \text{ V}$	1 11	25°C		0.08	0.14	
			High level —4	-40°C to 125°C			0.22	



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2.7-V ELECTRICAL CHARACTERISTICS

 V_{CC+} = 2.7 V, V_{CC-} = 0 V, V_{IC} = 1 V, V_{O} = 1.35 V, and R_{L} > 1 M Ω (unless otherwise noted)

	PARAMETER	TEST CONDIT	IONS	T _A	MIN	TYP	MAX	UNIT
V _{IO}	Input offset voltage			25°C		1	6	mV
VЮ	input onset voltage			-40°C to 125°C			6	111 V
α_{VIO}	Average temperature coefficient of input offset voltage			25°C		1		μV/°C
	Input bigg current			25°C		30	90	n 1
IB	Input bias current			-40°C to 125°C			140	nA
1	lanut offect current			25°C		0.5	30	- A
I _{IO}	Input offset current			-40°C to 125°C			50	nA
CMDD	Common mode rejection ratio	V 04-47V		25°C	70	85		٩D
JIVIKK	Common-mode rejection ratio	$V_{IC} = 0$ to 1.7 V		-40°C to 125°C	68			иь
. 1.	Positive supply-voltage	$V_{CC+} = 1.7 \text{ V to 4 V}, V_{CC-} = -1 \text{ V},$		25°C	75	85		dB
+k _{SVR}	rejection ratio	$V_{O} = 0, V_{IC} = 0$		-40°C to 125°C	70			dB
1.	Negative supply-voltage	V _{CC+} = 1.7 V, V _{CC} - = -1	V to -3.3 V,	25°C	73	85		
-k _{SVR}	rejection ratio	1/ 0 1/ 0		-40°C to 125°C	70			dB
V _{ICR}	Common-mode input voltage range	CMRR ≥ 50 dB		25°C	-0.2 to 1.9	-0.3 to 2		V
		$R_L = 600 \Omega \text{ to } 1.35 \text{ V},$	0	25°C	90	100		V dB
		$V_0 = 1.35 \text{ V to } 2.2 \text{ V}$	Sourcing	-40°C to 125°C	85			
		$R_1 = 600 \Omega \text{ to } 1.35 \text{ V},$	Ointrin -	25°C	85	90		
	l anno simul maltano amalification	$V_0 = 1.35 \text{ V to } 0.5 \text{ V}$	Sinking	-40°C to 125°C	80			
٩ _V	Large-signal voltage amplification	$R_1 = 2 k\Omega \text{ to } 1.35 \text{ V},$	0	25°C	95	100		
		$V_0 = 1.35 \text{ V to } 2.2 \text{ V}$	Sourcing	-40°C to 125°C	90			
		$R_L = 2 k\Omega \text{ to } 1.35 \text{ V},$ Sinking	25°C	90	95			
			Sinking	-40°C to 125°C	85			
		$V_{CC+} = 2.7 \text{ V},$ $R_L = 600 \Omega \text{ to } 1.35 \text{ V}$	High level	25°C	2.5	2.58		
				-40°C to 125°C	2.4			
				25°C		0.13	0.2	1
,	Output aurica		Low level	-40°C to 125°C			0.3	
/ ₀	Output swing		I Park I and	25°C	2.6	2.66		V
		$V_{CC+} = 2.7 \text{ V},$	High level	-40°C to 125°C	2.5			
		$R_L = 2 k\Omega$ to 1.35 V	Lavolaval	25°C		0.08	0.12	
			Low level	-40°C to 125°C			0.2	1
1	0.1.1	V _O = 0 V	Sourcing	25°C	12	16		
0	Output current	V _O = 2.7 V	Sinking	25°C	12	26		mA
		LM\/004		25°C		0.22	0.3	
		LMV821		-40°C to 125°C			0.5	
ı	Cupality augment	LMV/000 /heth	\	25°C		0.45	0.6	m- A
CC	Supply current	LMV822 (both amplifiers)	-40°C to 125°C			0.8	mA
		LMV/004 (all faces a config		25°C		0.72	1	
		LMV824 (all four amplifie	ers)	-40°C to 125°C			1.2	



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2.7-V ELECTRICAL CHARACTERISTICS (continued)

 V_{CC+} = 2.7 V, V_{CC-} = 0 V, V_{IC} = 1 V, V_{O} = 1.35 V, and R_{L} > 1 M Ω (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	T _A	MIN TYP MAX	UNIT
SR	Slew rate ⁽¹⁾		25°C	1.7	V/µs
GBW	Gain bandwidth product	(2)	25°C	5	MHz
Фт	Phase margin	(2)	25°C	60	deg
	Gain margin	(2)	25°C	8.6	dB
	Amplifier-to-amplifier isolation	$V_{CC+} = 5 \text{ V}, R_L = 100 \text{ k}\Omega \text{ to } 2.5 \text{ V}^{(3)}$	25°C	135	dB
V_n	Equivalent input noise voltage	$f = 1 \text{ kHz}, V_{IC} = 1 \text{ V}$	25°C	45	nV/√ Hz
In	Equivalent input noise current	f = 1 kHz	25°C	0.18	pA/√ Hz
THD	Total harmonic distortion	$f = 1 \text{ kHz}, A_V = -2, R_L = 10 \text{ k}\Omega,$ $V_O = 4.1 V_{p-p}$	25°C	0.01	%

⁽¹⁾ Connected as voltage follower with 1-V step input. Value specified is the slower of the positive and negative slew rates.

⁴⁰⁻dB closed-loop dc gain, $C_L = 22 \text{ pF}$ Each amplifier excited in turn with 1 kHz to produce $V_O = 3 V_{p-p}$



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5-V ELECTRICAL CHARACTERISTICS

 $\underline{V_{CC+}}$ = 5 V, V_{CC-} = 0 V, V_{IC} = 2 V, V_{O} = 2.5 V, and R_{L} > 1 $M\Omega$ (unless otherwise noted)

	PARAMETER	TEST CONDI	TIONS	T _A	MIN	TYP	MAX	UNIT
V _{IO}	Input offset voltage			25°C		1	6	mV
V10	input onoct voltage			-40°C to 125°C			6	111 V
α_{VIO}	Average temperature coefficient of input offset voltage			25°C		1		μV/°C
	Input bias current			25°C		40	100	nA
I _{IB}	input bias current			-40°C to 125°C			150	IIA
L.	Input offset current			25°C		0.5	30	nA
I _{IO}	input onset current			-40°C to 125°C			50	IIA
CMPP	Common-mode rejection ratio	V _{IC} = 0 to 4 V		25°C	72	90		dB
Civilata	Common-mode rejection ratio			-40°C to 125°C	70			uБ
⊥k₌	Positive supply-voltage	$V_{CC+} = 1.7 \text{ V to 4 V, } V_{C}$	_C - = -1 V,	25°C	75	85		dВ
+k _{SVR}	rejection ratio	$V_{O} = 0, V_{IC} = 0$		–40°C to 125°C	70			uБ
k	Negative supply-voltage	$V_{CC+} = 1.7 \text{ V}, V_{CC-} = -1$	V to −3.3 V,	25°C	73	85		ЧD
–k _{SVR}	rejection ratio	$V_O = 0$, $V_{IC} = 0$		-40°C to 125°C	70			uБ
V _{ICR}	Common-mode input voltage range	CMRR ≥ 50 dB		25°C	-0.2 to 4.2	-0.3 to 4.3		V
		$R_L = 600 \Omega \text{ to } 2.5 \text{ V},$	Ci	25°C	95	95 105		dB
•		$V_0 = 2.5 \text{ V to } 4.5 \text{ V}$	Sourcing	Sourcing –40°C to 125°C	90			
		$R_1 = 600 \Omega \text{ to } 2.5 \text{ V},$	Circlein a	25°C	95	105		
	l anno simul maltano amalification	$V_0 = 2.5 \text{ V to } 0.5 \text{ V}$	Sinking	-40°C to 125°C	90			
A_V	Large-signal voltage amplification	$R_1 = 2 k\Omega$ to 2.5 V,	0	25°C	95	105		
		$V_0 = 2.5 \text{ V to } 4.5 \text{ V}$	Sourcing	-40°C to 125°C	90			
		$R_1 = 2 k\Omega$ to 2.5 V,	Cinking	25°C	95	105		
		$V_0 = 2.5 \text{ V to } 0.5 \text{ V}$	Sinking	-40°C to 125°C	90			
		$V_{CC+} = 5 \text{ V},$ $R_L = 600 \Omega \text{ to } 2.5 \text{ V}$	High level	25°C	4.75	4.84		
				-40°C to 125°C	4.6			
			Lavolaval	25°C		0.17	0.25	
.,	Output aurica		Low level	-40°C to 125°C			0.3	
Vo	Output swing		I link laval	25°C	4.85	4.9		V
		$V_{CC+} = 5 \text{ V},$	High level	-40°C to 125°C	4.8			
		$R_L = 2 k\Omega$ to 2.5 V	l our lovel	25°C		0.1	0.15	
			Low level	-40°C to 125°C			0.2	
		V 0.V	Ci	25°C	20	45		
	Output suggest	$V_O = 0 V$	Sourcing	-40°C to 125°C	15			A
I _O	Output current	V 5 V	Cipleina	25°C	20	40		mA
		V _O = 5 V	Sinking	-40°C to 125°C	15			1
		L N N / 0.04		25°C		0.3	0.4	
		LMV821		-40°C to 125°C			0.6	mA
	Cupply ourrent	LM\/922 /bath amplifier	-	25°C		0.5	0.7	
I _{CC}	Supply current	LMV822 (both amplifiers	>)	-40°C to 125°C			0.9	
		110,000		25°C		1	1.3	
		LMV824 (all four amplifi	ers)	-40°C to 125°C			1.5	



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5-V ELECTRICAL CHARACTERISTICS (continued)

 V_{CC+} = 5 V, V_{CC-} = 0 V, V_{IC} = 2 V, V_O = 2.5 V, and R_L > 1 M Ω (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	T _A	MIN TYP	MAX	UNIT
SR	Slew rate	$V_{CC+} = 5 V^{(1)}$	25°C	1.4 1.9		V/µs
GBW	Gain bandwidth product	(2)	25°C	5.5		MHz
Фт	Phase margin	(2)	25°C	64.2		deg
	Gain margin	(2)	25°C	8.7		dB
	Amplifier-to-amplifier isolation	$V_{CC+} = 5 \text{ V}, R_L = 100 \text{ k}\Omega \text{ to } 2.5 \text{ V}^{(3)}$	25°C	135		dB
V _n	Equivalent input noise voltage	f = 1 kHz, V _{IC} = 1 V	25°C	42		nV/√ Hz
In	Equivalent input noise current	f = 1 kHz	25°C	0.2		pA/√ Hz
THD	Total harmonic distortion	$f = 1 \text{ kHz}, A_V = -2, R_L = 10 \text{ k}\Omega, V_O = 4.1 V_{p-p}$	25°C	0.01		%

⁽¹⁾ Connected as voltage follower with 3-V step input. Value specified is the slower of the positive and negative slew rates.

⁴⁰⁻dB closed-loop dc gain, $C_L = 22 \text{ pF}$ Each amplifier excited in turn with 1 kHz to produce $V_O = 3 V_{p-p}$

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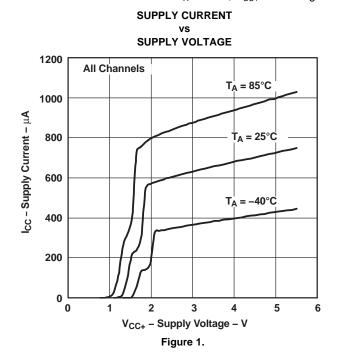


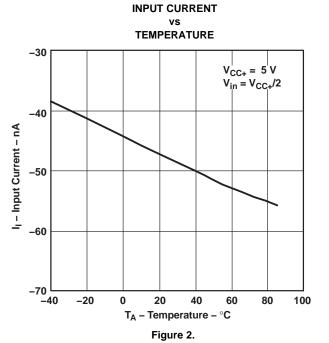
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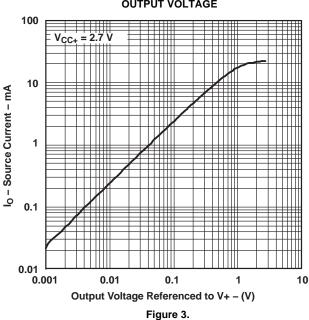
TYPICAL CHARACTERISTICS

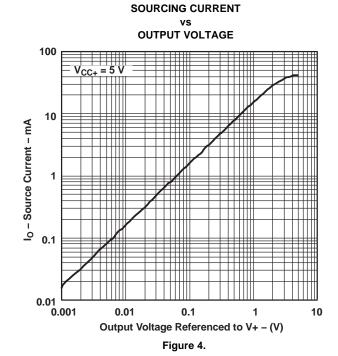
 $T_A = 25$ °C, $V_{CC+} = 5$ -V single supply (unless otherwise noted)





SOURCING CURRENT OUTPUT VOLTAGE





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TYPICAL CHARACTERISTICS (continued)

 $T_A = 25$ °C, $V_{CC+} = 5$ -V single supply (unless otherwise noted)

SINKING CURRENT

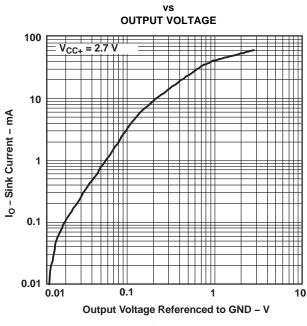


Figure 5.

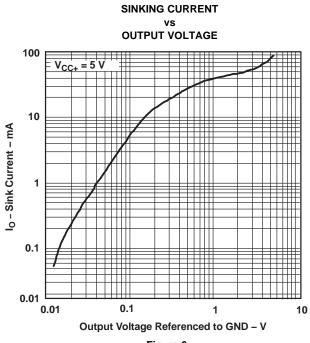
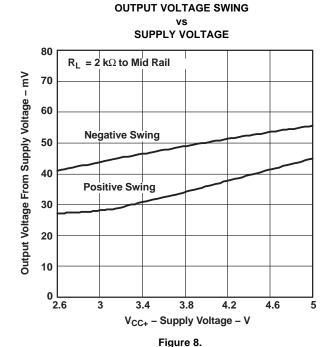


Figure 6.

OUTPUT VOLTAGE SWING VS SUPPLY VOLTAGE The state of the state of



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TYPICAL CHARACTERISTICS (continued)

 $T_A = 25$ °C, $V_{CC+} = 5$ -V single supply (unless otherwise noted)

OUTPUT VOLTAGE SWING

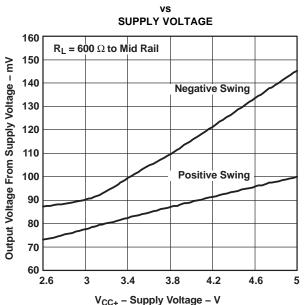
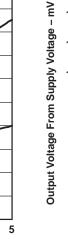


Figure 9.

CROSSTALK REJECTION



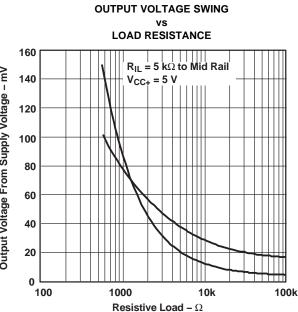
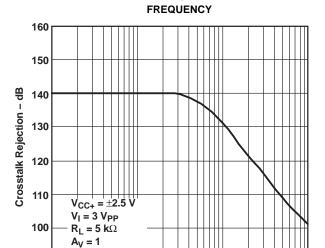
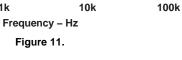


Figure 10.

+PSRR



1k



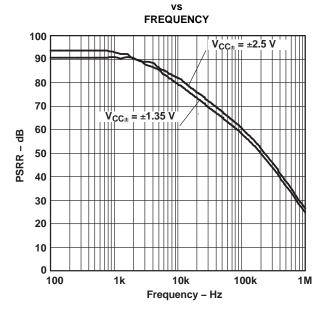


Figure 12.

90 100

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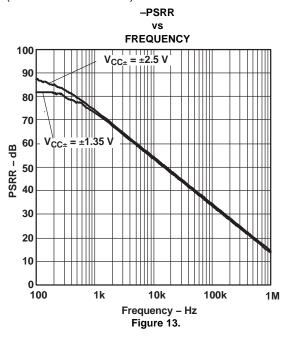
LMV821-Q1 LMV822-Q1 LMV824-Q1

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TYPICAL CHARACTERISTICS (continued)

 $T_A = 25$ °C, $V_{CC+} = 5$ -V single supply (unless otherwise noted)



GAIN AND PHASE MARGIN

FREQUENCY $(V_{CC+} = 2.7 \text{ V}, R_L = 600 \Omega, 2 \text{ k}\Omega, 100 \text{ k}\Omega)$ 80 140 120 70 Phase 100 60 80 50 Phase Margin - Deg 60 40 Gain - dB 30 Gain 20 20 0 10 $'_{CC+} = 2.7 \text{ V}$ -20 0 **600** Ω **2 k**Ω -40 -10100 $k\Omega$ -20 -60 1k 10k 100k 10M Frequency - Hz

Figure 14.

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TYPICAL CHARACTERISTICS (continued)

 $T_A = 25$ °C, $V_{CC+} = 5$ -V single supply (unless otherwise noted)

GAIN AND PHASE MARGIN

FREQUENCY $(V_{CC+} = 5 \text{ V}, R_L = 600 \Omega, 2 \text{ k}\Omega, 100 \text{ k}\Omega)$ 80 140 70 120 100 60 Phase 80 50 Phase Margin - Deg 40 60 40 30 20 20 Gain 10 0 V_{CC+} = 5 V 0 600 Ω -10 -40 100 $\mathbf{k}\Omega$ -60 -20 1M 10k 10M 100k Frequency - Hz

Figure 15.

GAIN AND PHASE MARGIN

FREQUENCY $(V_{CC+} = 2.7 \text{ V}, R_L = 10 \text{ k}\Omega, C_L = 22 \text{ pF}, 100 \text{ pF}, 200 \text{ pF})$ 80 100 70 80 60 60 50 Phase Margin - Deg 20 Gain - dB 40 30 20 Gain -40 10 $V_{CC+} = 2.7 V$ $R_L = 10 \text{ k}\Omega$ -60 0 22 pF 100 pF -80 200 pF -100 -20 10k 100k 1M 1k 10M Frequency - Hz

Figure 16.

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TYPICAL CHARACTERISTICS (continued)

 $T_A = 25$ °C, $V_{CC+} = 5$ -V single supply (unless otherwise noted)

GAIN AND PHASE MARGIN

FREQUENCY $(V_{CC+} = 5 \text{ V}, R_L = 10 \text{ k}\Omega, C_L = 22 \text{ pF}, 100 \text{ pF}, 200 \text{ pF})$ 80 100 70 80 60 60 50 40 Phase Margin – Deg 40 20 0 30 Gain 20 10 -40 $V_{CC+} = 5 V$ $R_L = 10 \text{ k}\Omega$ 0 -60 22 pF 100 pF -10 -80 200 pF -100 -20 10k 100k 1M 10M

Figure 17.

Frequency - Hz

GAIN AND PHASE MARGIN

FREQUENCY $(V_{CC+} = 2.7 \text{ V}, R_L = 600 \Omega, C_L = 22 \text{ pF}, 100 \text{ pF}, 200 \text{ pF})$ 140 80 120 70 100 60 50 Phase Margin – Deg 60 40 Gain - dB 40 30 20 20 $V_{CC+} = 2.7 \text{ V}$ 10 $R_L = 600 \Omega$ 22 pF 0 -20 100 pF -10 200 pF -40 ____60 10M -20 10k 1k 100k 1M Frequency - Hz

Figure 18.

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TYPICAL CHARACTERISTICS (continued)

 $T_A = 25$ °C, $V_{CC+} = 5$ -V single supply (unless otherwise noted)

GAIN AND PHASE MARGIN

 $\label{eq:vs} FREQUENCY\\ (V_{CC+}=5~V,~R_L=600~\Omega,~C_L=22~pF,~100~pF,~200~pF)$

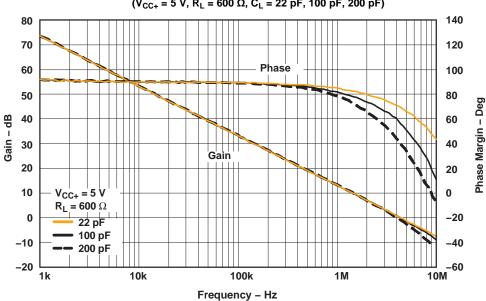


Figure 19.



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PACKAGE OPTION ADDENDUM

18-Dec-2015

PACKAGING INFORMATION

Orderable Device Status Package Type Package Pins Package Lead/Ball Finish Device Marking Eco Plan MSL Peak Temp Op Temp (°C) Samples Drawing Qty (1) (2) (6) (3) (4/5)LMV821QDBVRQ1 OBSOLETE TBD RB1B SOT-23 DBV Call TI -40 to 125 Call TI

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Ti's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish

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PACKAGE OPTION ADDENDUM

18-Dec-2015

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

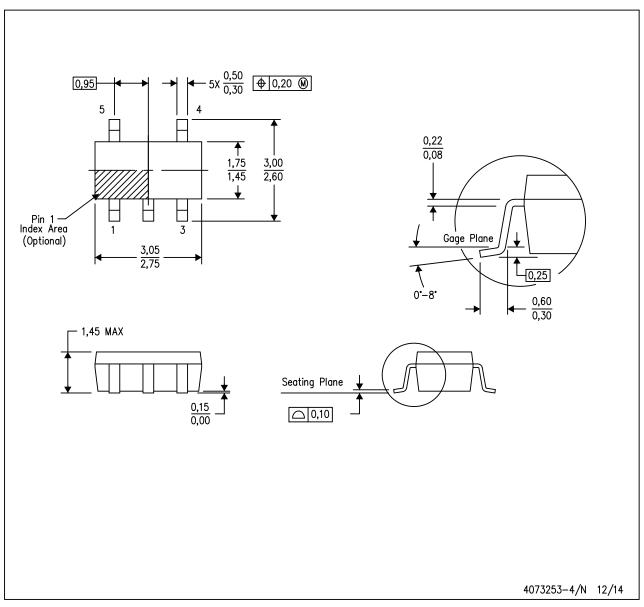




MECHANICAL DATA

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-178 Variation AA.





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